

Module #4 assembled at UniGe

Module completion on April 14th 2010

List of hybrids used:

- H0 and H1 glued on the top side of the module
- H2 and H3 glued on the bottom side of the module

NB: - All hybrids were produced in Japan and are from the latest KEK hybrid design
 - *All hybrids were set with the on-chip regulator ON (Only Vdd supply of 2.5V needed)*

Hybrids

Hybrid ID	Hybrid type	Module Id	Channel defects before assembly	Test before assembly	Test date
HKX2019	H0	#4	ch #746 col0 dead	ok	24.03.2010
HKX2020	H1		-	ok	24.03.2010
HKX2021	H2		-	ok	24.03.2010
HKX2022	H3		-	ok	23.03.2010

Baseboard

- **Detectors from Series 2 FZ1 p-stop** W63(top) and W64(Bottom) glued to baseboard
- **TPG coated with parylene** → decided to do parylene coating since module#1
- **HV tongue wire bonded** (no electrical conductive glue)